L Number	Hits	Search Text	DB	Time stamp
1	2	("5387314").PN.	USPAT;	2004/02/20 12:46
			US-PGPUB; EPO; JPO;	
	46	(ink-jet or (ink adj jet) or inkjet) and (forming adj2 slots)	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/12/09 11:42
-	20	("5317346" "5387314" "5519423" "5751317" "5980017" "6003986" "6019457" "6039437" "6053599" "6062681" "6109744" "6113223" "6132033" "6161923" "619980" "6224197" "6270198" "6280642" "6299673" "6331055" "2001/0003460").PN.	IBM_TDB	2003/12/05 16:50
_	61	(ink-jet or (ink adj jet) or inkjet) and (fill adj2 slot\$1)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/12/08 17:53
-	50	(ink-jet or (ink adj jet) or inkjet) and (slot\$1 and (blade or saw\$3)).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/02/05 15:02
-	382	(216/27).CCLS.	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/12/05 16:59
-	975	(ink-jet or (ink adj jet) or inkjet) and (slot\$1).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/12/05 17:08
-	633	(29/890.1).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/12/05 17:09
-	163	(438/21).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/12/05 17:10
-	423	(blade and substrate and (cutting or dicing)).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/12/05 17:58
_	469	(blade and substrate and (cutting or dicing or etching)).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/12/05 17:41
-	18	((ink-jet or (ink adj jet) or inkjet or printhead or (print adj head)) and blade and substrate and (cutting or dicing or etching)).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/12/05 17:39
-	235	(blade and substrate and (cut or dice\$1)).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/12/08 16:40

	429	(216/17).CCLS.	USPAT;	2003/12/05 17:43
	427	(210/17).0005.	US-PGPUB;	2003/12/03 17:43
			EPO; JPO;	
	Į.		DERWENT;	
			IBM TDB	
-	877	(216/52).CCLS.	USPAT;	2003/12/05 17:51
		,	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	660	(438/113).CCLS.	USPAT;	2003/12/05 17:53
ļ			US-PGPUB;	
			EPO; JPO;	
	İ		DERWENT; IBM TDB	
_	1	("6527965").PN.	USPAT;	2003/12/05 17:57
	1	(0327903).EN.	US-PGPUB;	2003/12/03 17:37
			EPO; JPO;	
			DERWENT;	
ļ.			IBM TDB	
· -	151	(blade and dic\$3 and (etch\$3 or	USPAT;	2003/12/05 18:00
	1	laser)).ab.	US-PGPUB;	
			EPO; JPO;	
		·	DERWENT;	
			IBM_TDB	
-	162	((manual or amulo) and manual and (organic or	USPAT;	2003/12/05 18:00
		laser)).clm.	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	ļ.
	214	(/blada an ang/2) and dia62 and /abab62 and	IBM_TDB	0000/10/05 10 00
-	314	((blade or saw\$3) and dic\$3 and (etch\$3 or laser)).ab.	USPAT;	2003/12/05 18:00
		laser,, ab.	US-PGPUB; EPO; JPO;	. 1
			DERWENT;]
	i	,	IBM TDB	
_	61	(blade and dic\$3 and (etch\$3 or	USPAT;	2003/12/05 18:01
		laser)).clm.	US-PGPUB;	2003/12/03 10:01
			EPO; JPO;	1
			DERWENT;]
			IBM TDB	1.
-	3356	1 (USPAT;	2003/12/08 16:54
		or dice\$1) and (wafer\$1 or	US-PGPUB;	
		substrate\$1)).ab.	EPO; JPO;	
			DERWENT;]
1_	300	//blade on course ind /	IBM_TDB	0000/10/00 55
-	308	((blade or saw\$3) and (cut\$3 or separat\$3 or dice\$1) and (wafer\$1 or	USPAT;	2003/12/08 16:42
		substrate\$1)).ti.	US-PGPUB; EPO; JPO;	
		3000ctdcc41/1.ct.	DERWENT;	
			IBM TDB	
-	86	((blade or saw\$3) and (cut\$3 or separat\$3	USPAT;	2003/12/08 17:10
		or dice\$1) and (wafer\$1 or substrate\$1).	US-PGPUB;	=
]		and ink).ab.	EPO; JPO;	
	:		DERWENT;	
1			IBM_TDB	
-	4	(((grit or sand or media) adj (blast\$3 or	USPAT;	2003/12/08 17:13
		drill\$3)) and (cut\$3 or separat\$3 or	US-PGPUB;	
]		dice\$1) and (wafer\$1 or substrate\$1) and	EPO; JPO;	
1		ink).ab.	DERWENT;	
_	140	///arit or eard or modial add /blacking	IBM_TDB	0000 /10 /00 17 15
	140	(((grit or sand or media) adj (blast\$3 or drill\$3)) and ink).ab.	USPAT;	2003/12/08 17:13
		dilitys;; and ink;.db.	US-PGPUB;	
			EPO; JPO; DERWENT;	
			IBM TDB	
-	43	(((grit or sand or media) adj (blast\$3 or	USPAT;	2003/12/08 17:15
] i		drill\$3)) and (inkjet or ink-jet or (ink	US-PGPUB;	2003/12/00 17.13
		adj jet) or ((ink or feed) near3	EPO; JPO;	
		slots))).ab.	DERWENT;	
			IBM TDB	
				L

-	22		USPAT;	2003/12/08 18:10
		(saw\$3 with (drill\$3 or laser or blast\$3 or ablat\$3) with etch\$3)	US-PGPUB; EPO; JPO;	
		Or abracos, with ecchos,	DERWENT;	
		•	IBM TDB	
-	24		USPĀT	2003/12/08 17:59
	Ì	"5248998" "5311218" "5351375"		
		"5359760" "5365645" "5421071"		•
		"5485663" "5581861" "5590451" "5598196" "5600357" "5650810"		
-		"5688391" "5697144" "5725825"		
		"5758396" "5809646" "5818479"		
		"5820771" "5904892" "5924197").PN.		
-	4	(("5227813") or ("5028937")).PN.	USPAT;	2003/12/08 18:01
			US-PGPUB;	
•			EPO; JPO; DERWENT;	
			IBM TDB	
_	3	(ink-jet or (ink adj jet) or inkjet) and	USPAT;	2003/12/08 18:13
		(saw\$3 with blast\$3 with etch\$3)	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
_	29	((ink-jet or (ink adj jet) or inkjet) and	IBM_TDB USPAT:	2003/12/09 11:47
		((feed or ink) adj slots)).ab.	US-PGPUB;	2003/12/03 11.47
			EPO; JPO;	
			DERWENT;	
		(IBM_TDB	0004/00/20 10 55
-	9	(saw\$3{or blade) and ((feed or ink) adj slots).ab.	USPAT;	2004/02/19 10:28
	ĺ	Siots).ab.	US-PGPUB; EPO; JPO;	
			DERWENT;	
			IBM TDB	
-	3		USPĀT;	2003/12/09 11:53
		(((feed or ink) adj slots)) same (blade or	US-PGPUB;	
		saw\$3))	EPO; JPO; DERWENT;	
			IBM TDB	
-	92	((ink-jet or (ink adj jet) or inkjet) and	USPAT;	2003/12/09 12:10
		(((supply or ink) adj channel\$1)) same	US-PGPUB;	
		(blade or saw\$3))	EPO; JPO;	
			DERWENT; IBM TDB	
-	265	((ink-jet or (ink adj jet) or inkjet or	USPAT;	2003/12/09 12:10
		printhead or print-head or (print adj	US-PGPUB;	
1		head)) and (((supply or ink) adj	EPO; JPO;	
1 .		channel\$1)) same (laser or drill\$3))	DERWENT;	·
1_	13	((ink-jet or (ink adj jet) or inkjet or	IBM_TDB USPAT;	2002/12/00 12 00
	13	rinthead or print-head or (print adj	USPAT; US-PGPUB;	2003/12/09 12:00
		head)) and (((supply or ink) adj	EPO; JPO;	*
		channel\$1)) same ((laser or drill\$3) and	DERWENT;	
		(blast\$3 or etch\$3) and (saw\$3 or blade)))	IBM_TDB	
-	38		USPAT;	2003/12/09 12:10
		(((supply or ink) adj channel\$1)) with (blade or saw\$3))	US-PGPUB; EPO; JPO;	
		1,2200 01 00,70//	DERWENT;	
	1		IBM TDB	
- .	117	((ink-jet or (ink adj jet) or inkjet or	USPĀT;	2003/12/09 12:10
1		printhead or print-head or (print adj	US-PGPUB;	,
		head)) and (((supply or ink) adj channel\$1)) with (laser or drill\$3))	EPO; JPO;	
		channerally with (raser of dilli23))	DERWENT; IBM TDB	
-	13	((ink-jet or (ink adj jet) or inkjet or	USPAT;	2003/12/09 12:23
	1	printhead or print-head or (print adj	US-PGPUB;	
		head)) and (((supply or ink) adj	EPO; JPO;	
		channel\$1)) with (blast\$3))	DERWENT;	
L	L		IBM TDB	L

	523		USPAT;	2003/12/09 12:10
		printhead or print-head or (print adj	US-PGPUB;	•
		head)) and (((supply or ink) adj	EPO; JPO;	1
		channel\$1)) with (etch\$3))	DERWENT;	
	554	/420 /460)	IBM_TDB	2002/12/02 12 06
-	554	(438/460).CCLS.	USPAT;	2003/12/09 12:26
	İ		US-PGPUB;	,
İ	į.		EPO; JPO;	=
			DERWENT;	
	481	(438/462).CCLS.	IBM_TDB USPAT;	2003/12/09 12:35
[-	401	(436/462).CCLS.	US-PGPUB;	2003/12/09 12:35
			EPO; JPO;	
	1		DERWENT;	
			IBM TDB	
1_	215	(438/461).CCLS.	USPAT;	2003/12/09 12:35
	210	(100) 101/ 100201	US-PGPUB;	2003, 12, 03 12.33
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
_	73	(438/463).CCLS.	USPAT;	2003/12/09 12:35
.	_		US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
1	1		IBM TDB	
_	461	(((438/460).CCLS.) or ((438/462).CCLS.))	USPAT;	2003/12/09 13:01
1	1	and (blade or saw\$3)	US-PGPUB;	
1	1		EPO; JPO;]
			DERWENT;	
		·	IBM TDB	
i -	18	(((438/460).CCLS.) or ((438/462).CCLS.))	USPĀT;	2003/12/09 12:55
		and (blade or saw\$3) with (laser or	US-PGPUB;	
		drill\$3) with (etch\$3 or blast\$3)	EPO; JPO;	
			DERWENT;	
			IBM_TDB]
-	153	, , , , , , , , , , , , , , , , , , , ,	USPAT;	2003/12/09 12:52
	ĺ	and (blade or saw\$3) with ((laser or	US-PGPUB;	
		drill\$3) or (etch\$3 or blast\$3))	EPO; JPO;	1
			DERWENT;	
			IBM_TDB	
	39	((,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	USPAT;	2003/12/09 12:52
		and (blade or saw\$3) same (laser or	US-PGPUB;	
		drill\$3) same (etch\$3 or blast\$3)	EPO; JPO;	1
			DERWENT;	
_	801	(451/38).CCLS.	IBM_TDB	2003/12/09 12:55
		(431/30).0013.	USPAT;	2003/12/09 12:55
			US-PGPUB; EPO; JPO;	
			DERWENT;	
			IBM TDB	
-	385	(451/48).CCLS.	USPAT;	2003/12/09 12:58
		,	US-PGPUB;	-000, 12,00
			EPO; JPO;	
	*		DERWENT;	1
			IBM TDB	
-	4	((451/48).CCLS.) and (semiconductor or	USPAT;	2003/12/09 12:58
		wafer)	US-PGPUB;	=====
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
-	72	((451/38).CCLS.) and (semiconductor or	USPĀT;	2003/12/09 12:59
		wafer) .	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
] -	280		USPAT;	2003/12/09 13:03
		and (blade or saw\$3) and (\$5side or top or	US-PGPUB;	
'		bottom or back\$4).clm.	EPO; JPO;	
			DERWENT;	
_		5070114 HDDN	IBM_TDB	
	16	5272114.URPN.	USPĀT	2003/12/09 13:05
			·	

_	1519	<pre>(ink-jet or (ink adj jet) or inkjet) and (slot\$1 and (blade or saw\$3))</pre>	USPAT; US-PGPUB;	2004/02/05 15:02
			EPO; JPO; DERWENT; IBM TDB	
_	1109	<pre>((feed or ink) adj (slot\$1 or channel\$1)) with (laser or drill\$3 or saw\$3 or blade or etch\$3 or mill\$3)</pre>	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/02/19 17:33
	, i	((feed or ink) adj (slot\$1 or channel\$1)) with ((laser or drill\$3) and (saw\$3 or blade) and (etch\$3 or mill\$3))	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/02/19 10:31
-	130	((feed and ink) with (slot\$1 or channel\$1)) with (laser or drill\$3 or saw\$3 or blade or etch\$3 or mill\$3)	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/02/19 13:41
_	2	("6271102").PN.	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/02/19 12:42
_	22	("4015175" "4104697" "4292576" "4312115" "4721977" "4729971" "4814296" "4846032" "4900283" "4985982" "5000811" "5217907" "5219796" "5272114" "5369060" "5477065" "5786266" "5843831" "5858808" "5943591" "5998238" "6124148").PN.	IBM_TDB USPAT	2004/02/19 12:42
-	11	((feed and ink) with (slot\$1 or channel\$1)) with (aspect adj ratio)	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/02/19 13:42
-	55	((feed or ink) with (slot\$1 or channel\$1)) with (aspect adj ratio)	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/02/19 14:01
_	119	<pre>((ink adj jet) or inkjet or ink-jet or printhead) and ((slot\$1 or channel\$1) with (aspect adj ratio))</pre>	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/02/19 14:03
-	19	((ink adj jet) or inkjet or ink-jet or printhead) and ((slot\$1 or channel\$1) with (aspect adj ratio)) and (blade or saw\$3)	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/02/19 14:02
_	50	((ink adj jet) or inkjet or ink-jet or printhead) and ((slot\$1 or channel\$1) with (aspect adj ratio)) and (blade or saw\$3 or drill\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/02/19 14:04
	30	((ink adj jet) or inkjet or ink-jet or printhead) and ((slot\$1 or channel\$1) with (aspect adj ratio)) and (blade or saw\$3 or drill\$3) and silicon	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/02/19 14:04
_	155	((feed or ink) adj (slot\$1 or channel\$1)) with drill\$3	IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2004/02/19 17:34
			DERWENT; IBM_TDB	

-	. 44	(ink adj (slot\$1 or channel\$1)) with drill\$3	USPAT; US-PGPUB;	2004/02/19 18:05
			EPO; JPO;	
			DERWENT;	
	100	(waterway and large) (1) 1/21202	IBM_TDB	2004/02/10 17:20
-	123	(rotary and laser) with drill\$3	USPAT; US-PGPUB;	2004/02/19 17:38
			EPO; JPO;	
			DERWENT;	
	1.0	(IBM_TDB USPAT;	2004/02/19 17:38
-	16	(rotary and laser) with drill\$3 and silicon	US-PGPUB;	2004/02/19 17:38
			EPO; JPO;	
		* .	DERWENT;	
_	9	(rotary and laser) adj drill\$3	IBM_TDB USPAT;	2004/02/19 17:39
		(localy and lasel) adj dillios	US-PGPUB;	2004/02/19 17.55
			EPO; JPO;	
		•	DERWENT;	
_	8	(rotary adj drill\$3) with silicon	IBM_TDB USPAT:	2004/02/19 17:39
	ľ	(Totaly day drillys) with silicon	US-PGPUB;	2004/02/15 17.55
			EPO; JPO;	
			DERWENT;	
_	13	(diamond adj (blade or saw)) same	IBM_TDB USPAT;	2004/02/19 18:07
		((diamond or rotary) adj drill\$3)	US-PGPUB;	
			EPO; JPO;	
			DERWENT; IBM TDB	
-	26	(diamond adj2 (blade or saw)) same	USPAT;	2004/02/19 18:07
		((diamond or rotary) adj2 drill\$3)	US-PGPUB;	
			EPO; JPO;	
			DERWENT; IBM TDB	
-	12	(diamond adj2 (blade or saw)) with	USPAT;	2004/02/19 18:07
		((diamond or rotary) adj2 drill\$3)	US-PGPUB;	
			EPO; JPO; DERWENT;	
			IBM TDB	
-	18	router with saw with slot	USPĀT;	2004/02/20 10:14
		•	US-PGPUB;	
			EPO; JPO; DERWENT;	
			IBM TDB	
-	260	(miter adj saw).ti.	USPAT;	2004/02/20 10:15
			US-PGPUB; EPO; JPO;	
			DERWENT;	
		/ / when and also and also are	IBM_TDB	0004/00/55 55
-	. 2	(router and slot and method).ti.	USPAT; US-PGPUB;	2004/02/20 10:15
			EPO; JPO;	
			DERWENT;	
_	156	(router same slot) ab	IBM_TDB	2004/02/20 10:07
	130	(router same slot).ab.	USPAT; US-PGPUB;	2004/02/20 10:27
.			EPO; JPO;	
			DERWENT;	*
_	71	router with slot\$2 with workpiece	IBM_TDB USPAT;	2004/02/20 10:30
	'	120001 HILL SIOCAT HICH HOLVELEGE	US-PGPUB;	2004/02/20 10:30
			EPO; JPO;	
			DERWENT;	
-	4	(router and saw) with slot\$2 with	IBM_TDB USPAT;	2004/02/20 10:31
]		workpiece	US-PGPUB;	2001,02,20 10.51
			EPO; JPO;	
			DERWENT;	
L	L		IBM_TDB	[